MOS FIELD EFFECT TRANSISTOR NP15P04SLG

SWITCHING **P-CHANNEL POWER MOSFET**

DESCRIPTION

The NP15P04SLG is P-channel MOS Field Effect Transistor designed for high current switching applications.

ORDERING INFORMATION

| PART NUMBER | LEAD PLATING | PACKING | PACKAGE | |
|-----------------------|---------------|------------------|------------------|--|
| NP15P04SLG-E1-AY Note | | | TO 050 (MD 07/4) | |
| NP15P04SLG-E2-AY Note | Pure Sn (Tin) | Tape 2500 p/reel | TO-252 (MP-3ZK) | |

Note Pb-free (This product does not contain Pb in external electrode.)

FEATURES

Super low on-state resistance

 $R_{DS(on)1} = 40 \text{ m}\Omega \text{ MAX.}$ (Vgs = -10 V, ID = -7.5 A)

 $R_{DS(on)2} = 60 \text{ m}\Omega \text{ MAX.} (V_{GS} = -4.5 \text{ V}, \text{ ID} = -7.5 \text{ A})$

- Low input capacitance
 - Ciss = 1100 pF TYP.
- · Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

| Drain to Source Voltage (Vgs = 0 V) | VDSS | -40 | V |
|---|----------|-------------|----|
| Gate to Source Voltage (VDS = 0 V) | Vgss | ∓20 | V |
| Drain Current (DC) (Tc = 25°C) | D(DC) | ∓15 | А |
| Drain Current (pulse) Note1 | D(pulse) | ∓45 | А |
| Total Power Dissipation (Tc = 25° C) | PT1 | 30 | W |
| Total Power Dissipation (T _A = 25°C) | Pt2 | 1.2 | W |
| Channel Temperature | Tch | 175 | °C |
| Storage Temperature | Tstg | -55 to +175 | °C |
| Single Avalanche Current Note2 | las | 16 | А |
| Single Avalanche Energy ^{Note2} | Eas | 25 | mJ |
| | | | |

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

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| Channel to Case Thermal Resistance | Rth(ch-C) | 5.0 | °C/W |
|---------------------------------------|-----------|-----|------|
| Channel to Ambient Thermal Resistance | Rth(ch-A) | 125 | °C/W |

2. Starting T_{ch} = 25°C, V_{DD} = -20 V, R_G = 25 Ω , V_{GS} = $-20 \rightarrow 0$ V

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Document No. D19077EJ2V0DS00 (2nd edition) Date Published March 2008 NS Printed in Japan

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| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|---------------------|---|------|------|------|------|
| Zero Gate Voltage Drain Current | loss | V _{DS} = -40 V, V _{GS} = 0 V | | | -10 | μA |
| Gate Leakage Current | lgss | V _{GS} = ∓20 V, V _{DS} = 0 V | | | ∓10 | μA |
| Gate to Source Threshold Voltage | $V_{\text{GS(th)}}$ | V_{DS} = V_{GS} , I_D = -250 μ A | -1.0 | -1.6 | -2.5 | V |
| Forward Transfer Admittance Note | y _{fs} | V _{DS} = -10 V, I _D = -7.5 A | 6 | 12 | | S |
| Drain to Source On-state Resistance Note | RDS(on)1 | V _{GS} = −10 V, I _D = −7.5 A | | 31 | 40 | mΩ |
| | RDS(on)2 | V _{GS} = -4.5 V, I _D = -7.5 A | | 38 | 60 | mΩ |
| Input Capacitance | Ciss | V _{DS} = -10 V, | | 1100 | | pF |
| Output Capacitance | Coss | V _{GS} = 0 V, | | 190 | | pF |
| Reverse Transfer Capacitance | Crss | f = 1 MHz | | 140 | | pF |
| Turn-on Delay Time | Td(on) | V_{DD} = -20 V, I _D = -7.5 A, | | 7 | | ns |
| Rise Time | Tr | V _{GS} = -10 V, | | 5 | | ns |
| Turn-off Delay Time | Td(off) | R _G = 0 Ω | | 100 | | ns |
| Fall Time | Tr | | | 65 | | ns |
| Total Gate Charge | QG | $V_{DD} = -32 V,$ | | 23 | | nC |
| Gate to Source Charge | Q _{GS} | V _{GS} = -10 V, | | 3 | | nC |
| Gate to Drain Charge | Qgd | I⊳ = −15 A | | 7 | | nC |
| Body Diode Forward Voltage Note | V _{F(S-D)} | IF = -15 A, VGS = 0 V | | 0.94 | 1.5 | V |
| Reverse Recovery Time | trr | IF = -15 A, VGS = 0 V, | | 32 | | ns |
| Reverse Recovery Charge | Qrr | di/dt = −100 A/ <i>μ</i> s | | 33 | | nC |

ELECTRICAL CHARACTERISTICS (TA = 25°C)

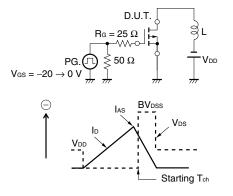
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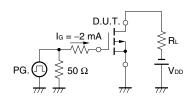
Note Pulsed test PW \leq 350 μ s, Duty Cycle \leq 2%

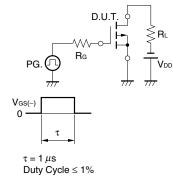
TEST CIRCUIT 1 AVALANCHE CAPABILITY

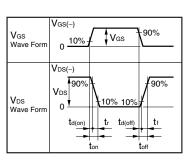
TEST CIRCUIT 2 SWITCHING TIME



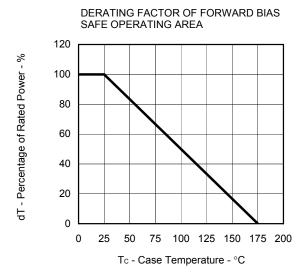
TEST CIRCUIT 3 GATE CHARGE



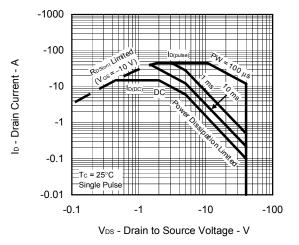


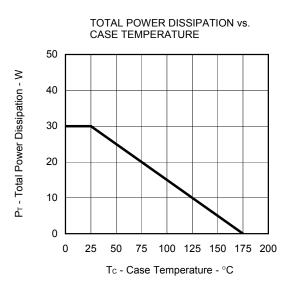


TYPICAL CHARACTERISTICS (T_A = 25°C)

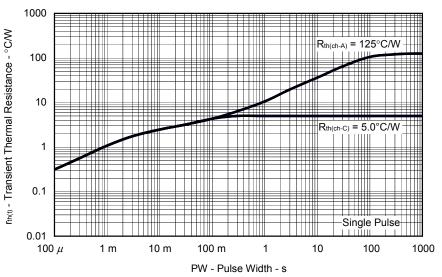




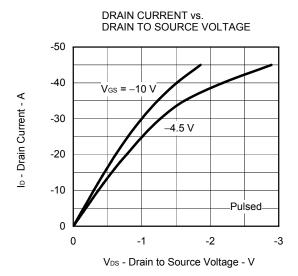




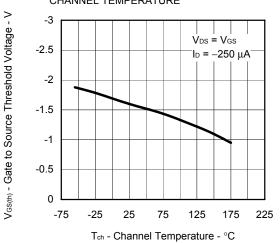
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

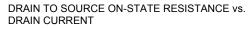


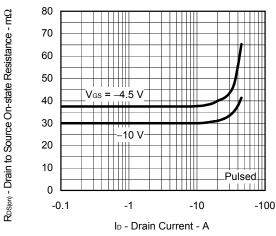
Data Sheet D19077EJ2V0DS

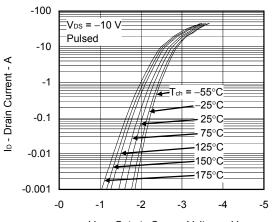








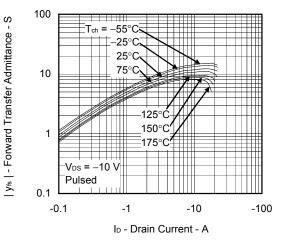


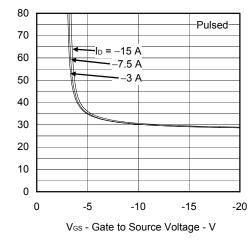


FORWARD TRANSFER CHARACTERISTICS



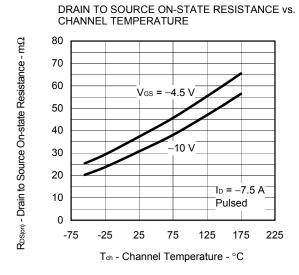
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



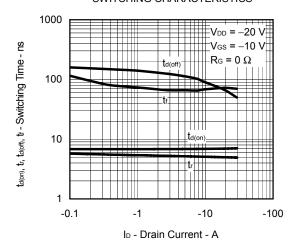


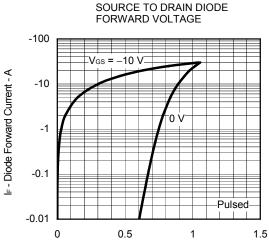
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

RDS(on) - Drain to Source On-state Resistance - mO



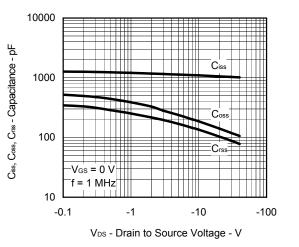
SWITCHING CHARACTERISTICS



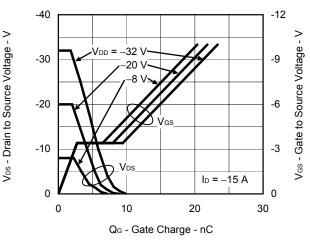


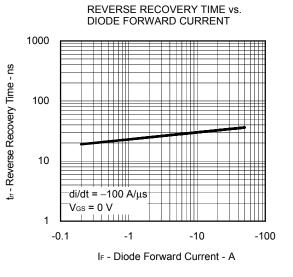
VF(S-D) - Source to Drain Voltage - V

CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

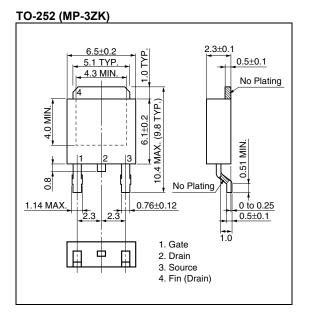


DYNAMIC INPUT/OUTPUT CHARACTERISTICS

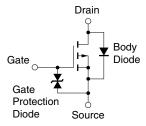




PACKAGE DRAWING (Unit: mm)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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